

Revision date: 10/8/2021

N109 W13300 ELLSWORTH DRIVE GERMANTOWN, WI 53022 262-253-5900 FAX 262-253-5919

DESCRIPTION:

Resinlab[®] *EP1121-4 Black* is a soft, highly filled, high viscosity, adhesive/casting resin. It is a thixotropic version of EP1200 to provide a non-flow, non-sag viscosity. It was designed for applications requiring a high degree of thermal conductivity and flexibility as well as a low CTE; its high elongation allows it to accommodate thermal shock and to enhance the cycling properties. It contains abrasive aluminum oxide filler to introduce wear considerations for wetted components. It also gives good resistance to inorganic acids, salt water, and most organic compounds.

It was especially formulated to a 1A:1B volume mix ratio for use in side-by-side dispensing cartridges and meter, mix, and dispense (MMD) equipment. It shows very good stability in side-by-side cartridges.

At room temperature, *EP1121-4 Black* will reach handle cure at 24 hours. Final cure properties can be achieved more quickly by the application of heat after product has gelled. Cure times and temperatures typical for most applications range from 2 hours at 65 °C to 30 minutes at 100 °C. Time to heat substrate must be taken into account with cooler temperatures extending the work time.

TYPICAL PROPERTIES:

All properties given are at 25 °C unless otherwise noted.

Property:	Value:	Test Method or Source:
Color	Black	Visual
Mix Ratio	Part A to Part B	Calculated
Mix Ratio by weight	1.06 to 1	
Mix Ratio by volume	1 to 1	
Viscosity - Part A	400,000 cP	TA HR20 Rheometer 25mm parallel plate @
Viscosity - Part B	600,000 cP	1/s DCV6100723
Viscosity - Mixed	500,000 cP	
Specific Gravity - Part A	2.15	Calculated
Specific Gravity - Part B	2.11	
Specific Gravity - Mixed	2.13	
Pot Life defined as the time it takes for	1 hours	TA HR20 Rheometer parallel plate 25mm @
initial mixed viscosity to double		1/s DCV6100723
Hardness	80 Shore D	455300006287/ASTM D2240
Glass Transition Temperature/Tg	15 °C	453560822409 by DSC
Water Absorption	0-1%	24 hr immersion 457561824543/ASTM D570
Tensile Properties:		4535601224470/ASTM D638
Strength	1,900 psi	
Elongation	15 %	
Modulus	24,000 psi	
Lap Shear Strength		4535601224468/ASTM D1002
0.010" Bond Line, Al to Al	2,000 psi	

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TECHNICAL DATA SHEET EP1121-4 Black

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Property:	Value:	Test Method or Source:
Compressive Properties:		4535601224467/ASTM D695
Yield Strength	7,400 psi	
Ultimate Strength	10,200 psi	
Modulus	58,000 psi	
Thermal Conductivity by LFA	1.1 W/m.K	453560822409/ASTM E1461
Volume Resistivity	3.7 x 10 ¹⁴ ohm-cm	455300006612/ASTM D257
		@ 19 °C @ 23 %RH
Surface Resistivity	2.8 x 10 ¹⁶ ohm/sq	455300006612/ASTM D257
		@ 19 °C @ 23 %RH
Dielectric Constant & Dissipation Fac	tor	455300006513/ASTM D150
@ 100 Hz	5.6, 0.05	
@ 100 kHz	4.9, 0.02	
AC Dielectric Strength	17.2 kV/mm *	ASTM D149 Method A, immersed in ASTM
		D3487 Type II Oil
Coefficient of Thermal Expansion by	ТМА	455300005340/ASTM E831 TMA, 5 °C/min
below Tg	35 ppm/°C	
above Tg	130 ppm/°C	
Operating Temperature Range	-40 to 150 °C**	
Relative Thermal Index (RTI)	90 °C	UL746B, Table 7.1
		Generic Value Based on Composition

* Asterisk denotes values considered typical to associated resin systems or extrapolated from other test results.

** Operating Temperature Range is based on average design requirements and is not intended as a guarantee of suitability for all applications operating at that temperature.

*** This TDS contains values that have been updated. The values reported in this technical data sheet are typical values of the product, and are highly dependent on test conditions and methodology. We actively seek the most precise and accurate ways to measure and interpret performance of our products, and to update estimated values with measured values. The formula has not been revised or changed in any way. Although the values on paper have changed, you can expect the same performance of the product.

INSTRUCTIONS:

- 1. Bring to room temperature prior to use.
- Cartridge format: Mixer should be attached keeping the cartridge vertical and any air pocket purged this way. After the mixer contains material, the mixer tip can be dropped to dispense pre-bleed amount. Attach a new static mixer with each cartridge, then pre-bleed the first 3 inches of dispensed material or until a uniform color is obtained. Maintain adequate velocity during dispensing to ensure complete mixing.

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- 3. Bulk format: stir until homogeneous weigh and mix parts A and B accurately and thoroughly, scraping sides of container often. Do not pour from mixing container, transfer to a new container as residual unmixed material may cause a tacky spot on the surface of the casting. Maintain adequate velocity during dispensing to ensure complete mixing.
- 4. Clean up uncured resin with suitable organic solvent such as MEK or acetone.
- 5. Allow to cure undisturbed until product is fully gelled or tack-free to the touch.

SHELF LIFE AND STORAGE:

12 months at 25 °C. Specialty packaging may be less.

Many epoxy resin systems are prone to crystallization as epoxy resin is a super-cooled fluid. This condition may give the product a gritty or grainy appearance (or hazy in clear products). Products in this state will not usually cure to normal and expected properties. In extreme cases it may appear solid and cured. Fluctuating temperatures (within 5 to 50 °C) aggravate this phenomenon. Heating the individual component to 50 to 60 °C while stirring can usually restore products to original state. Storage at 25 +/- 10 °C is optimum for most products.